## IN THE DRAWINGS:

The attached sheet of drawings includes changes to Fig. 5. This sheet, which includes Fig. 5, replaces the original sheet 6 including Fig. 5. In Figure 5, reference numeral 502 has been amended to indicate the lower portion of the second liner 118, as described in the specification. Further, reference numeral 502, as originally filed, has been changed to reference numeral 108 as described in the specification and shown in other Figures.

Attachment:

**Replacement Sheet** 

**Annotated Sheet Showing Changes** 

## **REMARKS**

Applicant respectfully requests the amended Figure 5 replace the sheet including Figure 5 as originally filed. Applicant submits no new matter has been added, and respectfully requests entry of the amended Figure 5.

Respectfully submitted,

Keith M. Tackett

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ANNOTATED SHEET

APPM/004150.D1(Y2)/ETCH/DRIE/MD-DAO

10/055,310 CONFIRMATION: 9294

JANUARY 22, 2002

APPLIED MATERIALS, INC.

TEMPERATURE CONTROLLED SEMICONDUCTOR PROCESSING

CHAMBER LINER

NOORBAKHSH, ET AL. FIGUR

INVENTOR:

FIGURE 5

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